# **Small Signal MOSFET**

20 V, 224 mA, Single N-Channel, 0.62 x 0.62 x 0.4 mm XLLGA3 Package

#### **Features**

- Single N-Channel MOSFET
- Ultra Small and Thin Package (0.62 x 0.62 x 0.4 mm)
- Low R<sub>DS(on)</sub> Solution in 0.62 x 0.62 mm Package
- 1.5 V Gate Voltage Rating
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### **Applications**

- Small Signal Load Switch
- Analog Switch
- High Speed Interfacing
- Optimized for Power Management in Ultra Portable Products

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise stated)

Parameter			Symbol	Value	Units
Drain-to-Source Voltage		$V_{DSS}$	20	V	
Gate-to-Source Voltage		$V_{GS}$	±8.0	V	
Continuous Drain	Steady	T <sub>A</sub> = 25°C	I <sub>D</sub>	224	mA
Current (Note 1)	State	T <sub>A</sub> = 85°C		162	
	t ≤ 5 s	T <sub>A</sub> = 25°C		241	
Power Dissipa- tion (Note 1)	Steady State	T <sub>A</sub> = 25°C	P <sub>D</sub>	120	mW
	t ≤ 5 s	T <sub>A</sub> = 25°C		139	
Pulsed Drain Current $t_p = 10 \mu s$		I <sub>DM</sub>	673	mA	
Operating Junction and Storage Temperature		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C	
Source Current (Body Diode)		I <sub>S</sub>	120	mA	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Units
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	1040	°C/W
Junction-to-Ambient – t ≤ 5 s (Note 1)	$R_{\theta JA}$	900	

- 1. Surface Mounted on FR4 Board using the minimum recommended pad size, (or  $2\ \text{mm}^2$ ), 1 oz Cu.
- 2. Pulse Test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2%.

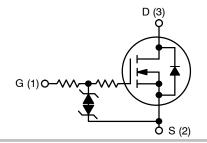


# ON Semiconductor®

#### http://onsemi.com

MOSFET			
V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX	
20 V	1.4 Ω @ 4.5 V		
	1.9 Ω @ 2.5 V	224 mA	
	2.2 Ω @ 1.8 V		
	4.3 Ω @ 1.5 V		

#### **N-Channel MOSFET**



# MARKING DIAGRAM



XLLGA3 CASE 713AB



A = Specific Device CodeM = Date Code

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTNS3193NZT5G	XLLGA3 (Pb-Free)	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Units
OFF CHARACTERISTICS				•			•
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	I <sub>D</sub> = -250 μA	A, ref to 25°C		19		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 20 V	T <sub>J</sub> = 25°C			1.0	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±8.0 V				±2.0	μА
ON CHARACTERISTICS (Note 3)				-			
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}$	I <sub>D</sub> = 250 μA	0.4		1.0	V
Negative Gate Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				1.9		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V <sub>3</sub>	, I <sub>D</sub> = 100 mA		0.65	1.4	Ω
		V <sub>GS</sub> = 2.5 \	/, I <sub>D</sub> = 50 mA		0.9	1.9	1
		V <sub>GS</sub> = 1.8 \	/, I <sub>D</sub> = 20 mA		1.1	2.2	1
		V <sub>GS</sub> = 1.5 \	/, I <sub>D</sub> = 10 mA		1.4	4.3	
Forward Transconductance	9FS	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 100 mA			0.56		S
Source-Drain Diode Voltage	$V_{SD}$	$V_{GS} = 0 V$	I <sub>S</sub> = 10 mA		0.55	1.0	V
CHARGES & CAPACITANCES							
Input Capacitance	C <sub>ISS</sub>	$V_{GS} = 0 \text{ V, f} = 1 \text{ MHz,} $ $V_{DS} = 15 \text{ V}$			15.8		pF
Output Capacitance	C <sub>OSS</sub>				3.5		
Reverse Transfer Capacitance	C <sub>RSS</sub>				2.4		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V, I <sub>D</sub> = 200 mA			0.70		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				0.05		
Gate-to-Source Charge	$Q_{GS}$				0.14		]
Gate-to-Drain Charge	$Q_GD$				0.10		
SWITCHING CHARACTERISTICS, VG	<b>S</b> = <b>4.5 V</b> (Note 3)						
Turn-On Delay Time	t <sub>d(ON)</sub>				18		ns
Rise Time	t <sub>r</sub>	$V_{GS} = 4.5 \text{ V}, V_{DD} = 15 \text{ V},$ $I_{D} = 200 \text{ mA}, R_{G} = 2 \Omega$			35		
Turn-Off Delay Time	t <sub>d(OFF)</sub>				201		]
Fall Time	t <sub>f</sub>				110		1

<sup>3.</sup> Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**

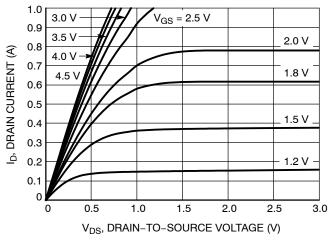


Figure 1. On-Region Characteristics

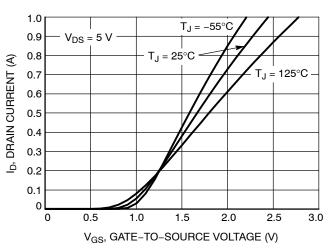


Figure 2. Transfer Characteristics

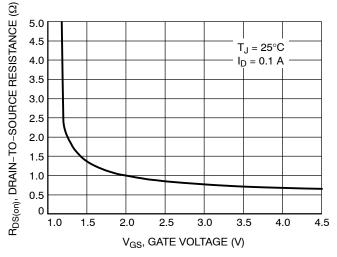


Figure 3. On-Resistance vs. Gate-to-Source Voltage

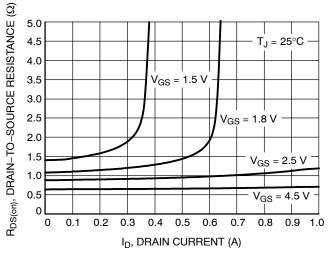


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

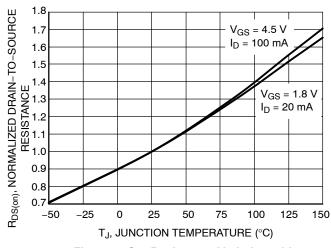


Figure 5. On–Resistance Variation with Temperature

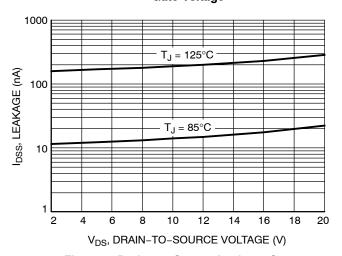
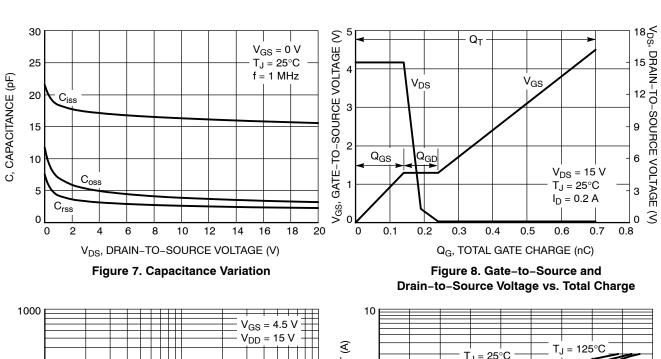


Figure 6. Drain-to-Source Leakage Current vs. Voltage

#### **TYPICAL CHARACTERISTICS**



IS, SOURCE CURRENT (A)  $T_{.1} = 25^{\circ}C$ t<sub>d(off)</sub> t, TIME (ns) 100 -55°C 0.1 t<sub>d(on)</sub> 0.0 10 8.0 10 100 0.4 0.5 0.7 0.9  $R_G$ , GATE RESISTANCE ( $\Omega$ ) V<sub>SD</sub>, SOURCE-TO-DRAIN VOLTAGE (V)

Figure 9. Resistive Switching Time Variation vs. Gate Resistance

0.85 V<sub>GS(th)</sub>, GATE-TO-SOURCE THRESHOLD 10 μs 0.75 DRAIN CURRENT (A) 100 μs  $I_D = 250 \, \mu A$ 0.1 VOLTAGE (V) 0.55 1 ms V<sub>GS</sub> ≤ 8 V Single Pulse 10 ms T<sub>C</sub> = 25°C 0.01  $R_{DS(on)}$  Limit dc ڡٞ 0.45 Thermal Limit Package Limit 0.35 0.001 50 75 125 150 100 -50 -25 0.1 T<sub>J</sub>, TEMPERATURE (°C) V<sub>DS</sub>, DRAIN-TO-SOURCE VOLTAGE (V)

Figure 11. Threshold Voltage

Figure 12. Maximum Rated Forward Biased Safe Operating Area

Figure 10. Diode Forward Voltage vs. Current

#### **TYPICAL CHARACTERISTICS**

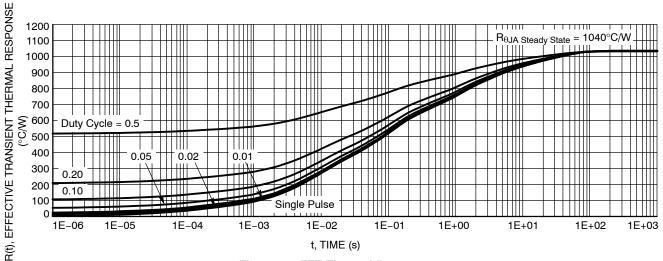
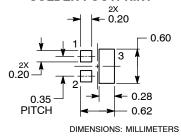


Figure 13. FET Thermal Response

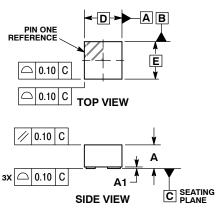
# MINIMUM RECOMMENDED SOLDER FOOTPRINT\*



<sup>\*</sup>Dependent upon end user capabilities, this footprint could be used as a minimum.

## PACKAGE DIMENSIONS

#### XLLGA3, 0.62x0.62, 0.35P CASE 713AB **ISSUE O**

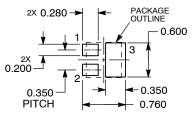


#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994 CONTROLLING DIMENSION: MILLIMETERS

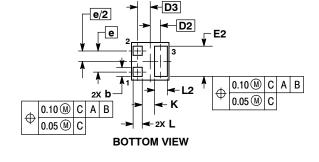
00.1022210 2			
	MILLIMETERS		
DIM	MIN	MAX	
Α	0.340	0.440	
A1	0.000	0.030	
b	0.100	0.200	
D	0.620 BSC		
D2	0.175 BSC		
D3	0.205 BSC		
Е	0.620 BSC		
E2	0.400	0.600	
е	0.350 BSC		
K	0.200 REF		
L	0.090	0.210	
L2	0.110	0.310	

#### **RECOMMENDED SOLDER FOOTPRINT\***



**DIMENSIONS: MILLIMETERS** 

\*Additional information concerning board mounting for this package may be found in Document AND9099/D, "Board Level Application Note for XLLGA 3-Lead 0.62x0.62 Package" For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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